

### **General Description**

The MAX1793 low-dropout linear regulator (LDO) operates from +2.5V to +5.5V and delivers a guaranteed 1A load current with a low 210mV dropout. The high-accuracy (±1%) output voltage is preset at an internally trimmed voltage (see the *Ordering Information*) or can be adjusted from 1.25V to 5.0V with an external resistor-divider.

An internal pMOS pass transistor allows a low 125µA supply current, making the MAX1793 ideal for batteryoperated portable equipment. Other features include a built-in reset output, low-power shutdown, and short-circuit and thermal-overload protection. The MAX1793 is available in a 1.5W, 16-pin power TSSOP package, which is 30% smaller than a SOT223 package and only 1.1mm high.

#### **Features**

- ♦ Guaranteed 1A Output Current
- ♦ Low 210mV Dropout at 1A
- ♦ Up to ±1% Output Voltage Accuracy Preset at 1.5V, 1.8V, 2.0V, 2.5V, 3.3V or 5.0V Adjustable from 1.25V to 5.0V
- ♦ Reset Output (4ms Delay)
- ♦ Low 125µA Ground Current
- ♦ 0.1µA Shutdown
- ♦ Low 115µVRMS Output Noise
- **♦ Thermal-Overload Protection**
- **♦ Output Current Limit**
- **♦ Tiny TSSOP Power Package (1.5W)** 30% Smaller than SOT223 (only 1.1mm high)

## **Ordering Information**

PART	TEMP RANGE	PIN- PACKAGE	Vо∪т <sup>†</sup> (V)
MAX1793EUE-50	-40°C to +85°C	16 TSSOP-EP*	5.0 or Adj
MAX1793EUE-33	-40°C to +85°C	16 TSSOP-EP*	3.3 or Adj
MAX1793EUE-33/V	-40°C to +85°C	16 TSSOP-EP*	3.3 or Adj

#### Ordering Information continued at end of data sheet

## **Applications**

Notebook Computers

Cordless Telephones

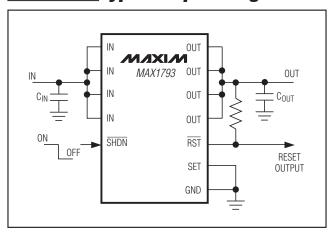
Cellular Phones

Modems

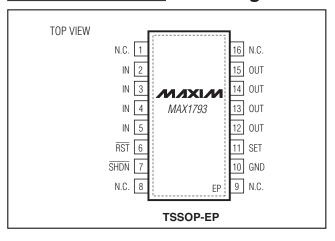
Hand-Held Instruments

PDAs and Palmtop Computers

### **Typical Operating Circuit**



### **Pin Configuration**



MIXIM

Maxim Integrated Products 1

For price, delivery, and to place orders, please contact Maxim Distribution at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

<sup>\*</sup>EP = Exposed pad.

<sup>†</sup>Contact factory for other preset output voltages.

<sup>/</sup>V Denotes an automotive qualified part.

### **ABSOLUTE MAXIMUM RATINGS**

IN, SHDN, RST to GND0.3V to +6V	Operating Temperature Range40°C to +85°C
OUT, SET to GND0.3V to (V <sub>IN</sub> + 0.3V)	Junction Temperature+150°C
Output Short-Circuit Duration	Storage Temperature Range65°C to +150°C
Continuous Power Dissipation (T <sub>A</sub> = +70°C)	Lead Temperature (soldering, 10s)+300°C
16-Pin TSSOP-EP (derate 19mW/°C above +70°C)1.5W	Soldering Temperature (reflow)+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = V_{OUT(NOM)} + 0.5V \text{ or } V_{IN} = 2.5V \text{ (whichever is greater)}, \overline{SHDN} = IN, T_A = +0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$  Typical values are at  $T_A = +25^{\circ}C.$ )

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Input Voltage	VIN			2.5		5.5	V
Input Undervoltage Lockout	V <sub>IN</sub>			2.0		2.3	V
		T <sub>A</sub> = +85°C,	Preset V <sub>OUT</sub> ≥ 2.5V	-1		+1	
		I <sub>OUT</sub> = 250mA	Preset Vout < 2.5V	-1.5		+1.5	
Output Voltage Accuracy (Preset Mode, SET = GND)		$T_A = 0$ °C to +85°C, I <sub>O</sub>	UT = 250mA	-2		+2	%
(Flesel Mode, SET = GIND)		$T_A = 0$ °C to +85°C, $I_O$ $V_{IN} > V_{OUT} + 0.5V$	UT = 1mA  to  1A,	-3		+3	
		T <sub>A</sub> = +85°C, I <sub>OUT</sub> = 25	50mA, V <sub>IN</sub> = 3V	1.229	1.250	1.271	
SET Voltage Threshold		$T_A = 0$ °C to +85°C, Io	UT = 250mA, V <sub>IN</sub> = 3V	1.219		1.281	V
(For Adjustable Output)		$T_A = 0$ °C to +85°C, $I_{OU}$	$T = 1$ mA to 1A, $V_{IN} = 3V$	1.212		1.288	1
Adjustable Output Voltage Range						5	V
Maximum Output Current	lout	Continuous, V <sub>IN</sub> ≥ 3V		1			ARMS
Short-Circuit Current Limit	I <sub>LIM</sub>	$V_{OUT} = 0$ , $V_{IN} \ge 3V$		1.1	1.8	3.3	А
In-Regulation Current Limit		V <sub>OUT</sub> within 4% of nominal output voltage, V <sub>IN</sub> = 5.5V			2.8		А
SET Pin Dual Mode Threshold				50		150	mV
SET Input Bias Current	ISET	V <sub>SET</sub> = +1.25V				±100	nA
Ground Current	IGND	I <sub>OUT</sub> = 100μA			125	200	μΑ
Drangust Valtage (Nata 1)	\/\/	I <sub>OUT</sub> = 1A,	MAX1793-33, -50		210	350	, val /
Dropout Voltage (Note 1)	VIN - VOUT	SET = GND	MAX1793-25		270	450	- mV
Line Regulation	$\Delta V_{LNR}$	V <sub>IN</sub> from (V <sub>OUT</sub> + 0.1V I <sub>OUT</sub> = 5mA, SET = GI		-0.15	0	+0.15	%/V
Load Regulation	$\Delta V_{LDR}$	I <sub>OUT</sub> = 100μA to 1A			0.7		%
Output Voltage Noise		10Hz to 1MHz, $C_{OUT} = 6.8\mu F$ (ESR < 0.1Ω)			115		μV <sub>RMS</sub>
Shutdown Supply Current	loff	SHDN = GND, V <sub>IN</sub> = +5.5V			0.1	16	μΑ
Output Pulldown Resistance in Shutdown		SHDN = GND			5		kΩ
SHDN Input Threshold	V <sub>I</sub> H V <sub>I</sub> L	+2.5V < V <sub>IN</sub> < +5.5V		1.6		0.6	V
SHDN Input Bias Current	ISHDN	SHDN = GND or IN			0.01	1	μΑ

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{IN} = V_{OUT(NOM)} + 0.5V \text{ or } V_{IN} = 2.5V \text{ (whichever is greater)}, \overline{SHDN} = IN, T_A = +0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$  Typical values are at  $T_A = +25^{\circ}C$ .)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
RST Output Low Voltage	VOL	I <sub>SINK</sub> = 1mA			0.1	V
Operating Voltage Range for RST Valid		I <sub>SINK</sub> = 100μA	1.0		5.5	V
RST Output High Leakage		$V_{\overline{RST}} = +5.5V$		0.01	1	μΑ
RST Trip Level Referred to Nominal Vout		Rising edge	90	94	96	% Vout
RST Release Delay		Rising edge	1.5	4.0	8.0	ms
Thermal Shutdown Temperature	TSHDN	Typical thermal hysteresis = 20°C		170		°C

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = V_{OUT(NOM)} + 0.5V \text{ or } V_{IN} = 2.5V \text{ (whichever is greater)}, \overline{SHDN} = IN, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.)}$ 

PARAMETER	SYMBOL	CON	DITIONS	MIN	TYP	MAX	UNITS
Input Voltage	VIN			2.5		5.5	V
Input Undervoltage Lockout	V <sub>IN</sub>			2.0		2.3	V
Output Voltage Accuracy		I <sub>OUT</sub> = 250mA		-2.5		2.5	%
(preset mode, SET = GND)		$I_{OUT} = 1$ mA to 1A, $V_{IN}$	> V <sub>OUT</sub> + 0.5V	-3.2		3.2	%
SET Voltage Threshold		$I_{OUT} = 250$ mA, $V_{IN} = 3$	V	1.216		1.284	V
(for adjustable output)		I <sub>OUT</sub> = 1mA to 1A, V <sub>IN</sub>	= 3V	1.210		1.290	V
Adjustable Output Voltage Range				1.25		5	V
Maximum Output Current	lout	Continuous, V <sub>IN</sub> ≥ 3V		1			ARMS
Short-Circuit Current Limit	ILIM	$V_{OUT} = 0, V_{IN} \ge 3V$	$V_{OUT} = 0$ , $V_{IN} \ge 3V$			3.3	А
SET Pin Dual Mode Threshold				50		150	mV
SET Input Bias Current	ISET	V <sub>SET</sub> = +1.25V				±100	nA
Ground Current	IGND	I <sub>OUT</sub> = 100μA				200	μΑ
Dropout Voltage (Note 1)	VIN -	I <sub>OUT</sub> = 1A,	MAX1793-33, -50			350	mV
Diopout Voltage (Note 1)	Vout	SET = GND	MAX1793-25			450	IIIV
Line Regulation	ΔV <sub>LNR</sub>	V <sub>IN</sub> from (V <sub>OUT</sub> + 0.1V) to +5.5V, I <sub>OUT</sub> = 5mA, SET = GND		-0.15		0.15	%/V
Shutdown Supply Current	loff	SHDN = GND, V <sub>IN</sub> = +5.5V				16	μΑ
SHDN Input Threshold	V <sub>IH</sub>	+2.5V < VIN < +5.5V		1.6			V
or ibra input miesnoid	V <sub>IL</sub>	- TZ.JV \ V  N \ TJ.JV				0.6	V
SHDN Input Bias Current	ISHDN	SHDN = GND or IN	SHDN = GND or IN			1	μΑ
RST Output Low Voltage	VoL	I <sub>SINK</sub> = 1mA				0.1	V



### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{IN} = V_{OUT(NOM)} + 0.5V \text{ or } V_{IN} = 2.5V \text{ (whichever is greater)}, \overline{SHDN} = IN, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.)}$  (Note 2)

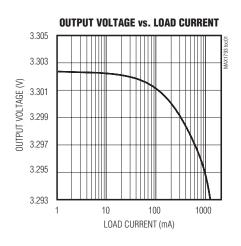
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage Range for RST Valid		ISINK = 10µA	1.0		5.5	V
RST Output High Leakage		V <sub>RST</sub> = +5.5V			1	μΑ
RST Trip Level Referred to Nominal V <sub>OUT</sub>		Rising edge	90		96	% Vout
RST Release Delay		Rising edge	1.5		8.0	ms

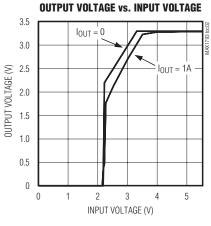
Note 1: Dropout voltage is defined as V<sub>IN</sub> - V<sub>OUT</sub>, when V<sub>OUT</sub> is 100mV below the value of V<sub>OUT</sub> measured when V<sub>IN</sub> = V<sub>OUT(NOM)</sub> + 0.5V. Since the minimum input voltage is 2.5V, this specification in only meaningful when V<sub>OUT(NOM)</sub> ≥2.5V. For V<sub>OUT(NOM)</sub> between 2.5V and 3.3V, use the following equations: Typical Dropout = 210mV + (3.3V - V<sub>OUT(NOM)</sub> × 75mV/V; Guaranteed Maximum Dropout = 350mV + (3.3V - V<sub>OUT(NOM)</sub> × 125mV/V. For V<sub>OUT(NOM)</sub> > 3.3V: Typical Dropout = 210mV; Guaranteed Maximum Dropout = 350mV.

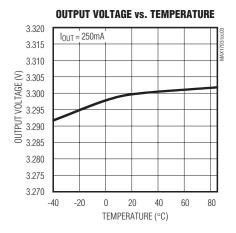
**Note 2:** Specifications to  $T_A = -40^{\circ}C$  are guaranteed by design and not production tested.

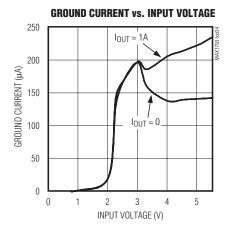
### Typical Operating Characteristics

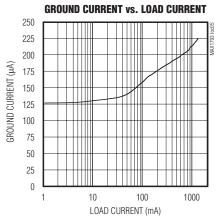
(Circuit of Figure 2,  $V_{IN} = +5V$ ,  $V_{\overline{SHDN}} = V_{IN}$ ,  $V_{OUT} = +3.3V$ ,  $T_A = +25$ °C, unless otherwise noted.)

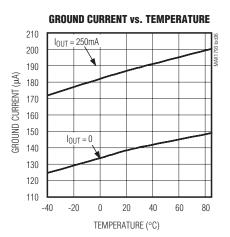








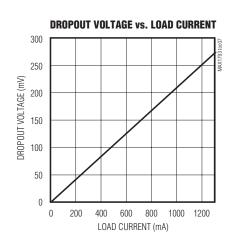


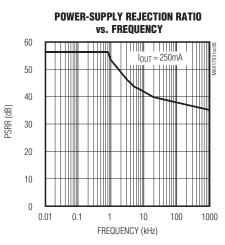


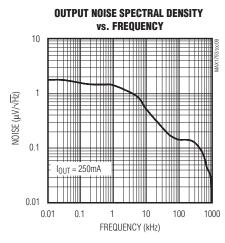
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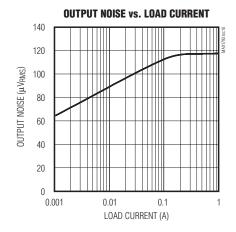
## Typical Operating Characteristics (continued)

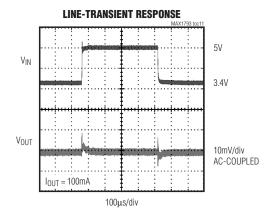
(Circuit of Figure 2, V<sub>IN</sub> = +5V, V<sub>SHDN</sub> = V<sub>IN</sub>, V<sub>OUT</sub> = +3.3V, T<sub>A</sub> = +25°C, unless otherwise noted.)

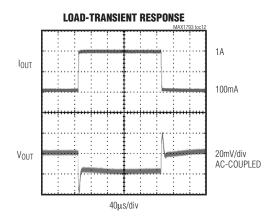


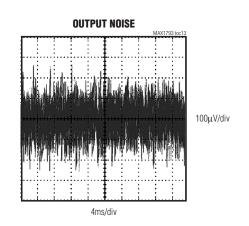






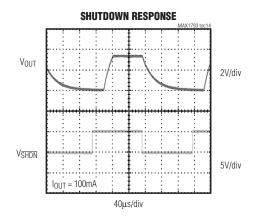


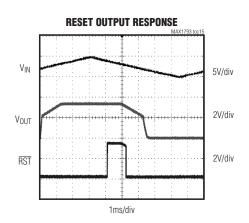




## Typical Operating Characteristics (continued)

(Circuit of Figure 2,  $V_{IN} = +5V$ ,  $V_{\overline{SHDN}} = V_{IN}$ ,  $V_{OUT} = +3.3V$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)





## **Pin Description**

PIN	NAME	FUNCTION
1, 8, 9, 16	N.C.	No Connection. Not internally connected.
2–5	IN	Regulator Input. Supply voltage ranges from +2.5V to +5.5V. Bypass with a 4.7µF capacitor to GND (see the <i>Capacitor Selection and Regulator Stability</i> ). These inputs are internally connected, but they also must be externally connected for proper operation.
6	RST	Reset Output. Open-drain output is low when $V_{OUT}$ is 6% below its nominal value. $\overline{RST}$ remains low while the output voltage ( $V_{OUT}$ ) is below the reset threshold and for at least 4ms after $V_{OUT}$ rises above the reset threshold. Connect a $100 \text{k}\Omega$ pullup resister to OUT to obtain an output voltage.
7	SHDN	Active-Low Shutdown Input. A logic-low disables the output and reduces the supply current to $0.1\mu A$ . In shutdown, the $\overline{RST}$ output is low and OUT is pulled low through an internal $5k\Omega$ resistance. Connect $\overline{SHDN}$ to IN for normal operation.
10	GND	Ground. This pin and the exposed pad also function as a heatsink. Solder both to a large pad or to the circuit-board ground plane to maximize power dissipation.
11	SET	Voltage-Setting Input. Connect to GND to select the factory-present output voltage. Connect SET to an external resistor-divider for adjustable-output operation.
12–15	OUT	Regulator Output. Bypass with a 6.8µF, low-ESR capacitor to GND. Connect all OUT pins together at the IC.

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### **Detailed Description**

The MAX1793 features Dual Mode™ operation, allowing a fixed output or an adjustable output from +1.25V to +5V. The regulators are guaranteed to supply 1A of output current.

As Figure 1 shows, the device consists of a +1.25V reference, error amplifier, MOSFET driver, p-channel pass transistor, internal feedback voltage-divider, Dual Mode comparator, and 4ms reset output.

The +1.25V reference is connected to the inverting input of the error amplifier. The error amplifier compares this reference with the selected feedback voltage and amplifies the difference. The MOSFET driver reads the error signal and applies the appropriate drive to the p-channel transistor. If the feedback voltage is lower than the reference, the pass transistor's gate is pulled

lower, allowing more current to pass and increase the output voltage. If the feedback voltage is high, the pass transistor's gate is pulled up, allowing less current to pass to the output. The low VouT comparator senses when the feedback voltage has dropped 6% below its expected level, causing RST to go low.

The output voltage is fed back through either an internal resistor-divider connected to OUT or an external resistor network connected to SET. The Dual Mode comparator examines V<sub>SET</sub> and selects the feedback path. If V<sub>SET</sub> is below 50mV, the internal feedback path is used and the output is regulated to the factory-preset voltage.

Dual Mode is a trademark of Maxim Integrated Products, Inc.

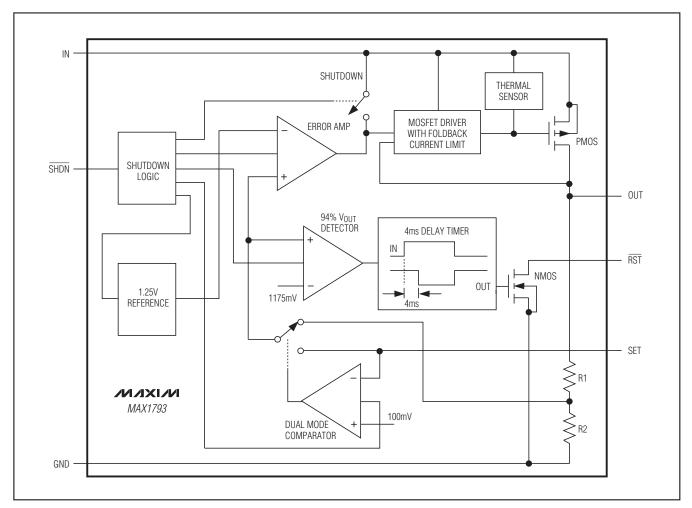


Figure 1. Functional Diagram

#### Internal p-Channel Pass Transistor

The MAX1793 features a 1A p-channel MOSFET pass transistor. Unlike similar designs using pnp pass transistors, p-channel MOSFETs require no base drive, which reduces quiescent current. pnp-based regulators also waste considerable current in dropout when the pass transistor saturates and use high base-drive currents under large loads. The MAX1793 does not suffer from these problems and consumes only 225µA of quiescent current under heavy loads, as well as in dropout.

#### **Output Voltage Selection**

The MAX1793 features Dual Mode operation. In preset voltage mode, the output of the MAX1793 is set to an internally trimmed voltage (see the *Ordering Information*). Select this mode by connecting SET to GND (Figure 2).

In adjustable mode, an output is selected between +1.25V and +5V using two external resistors connected as a voltage-divider to SET (Figure 3). The output voltage is determined by the following equation:

$$VOUT = VSET [1 + (R1/R2)]$$

where  $V_{SFT} = +1.25V$ . To simplify resistor selection:

$$R1 = R2 [(VOUT/VSET) - 1]$$

Since the input bias current at SET is less than 100nA, large resistance values can be used for R1 and R2 to minimize power consumption without losing efficiency. Up to  $125 \mathrm{k}\Omega$  is acceptable for R2.

In preset voltage mode, the impedance from SET to GND should be less than  $10k\Omega.$  Otherwise, spurious conditions could cause the voltage at SET to exceed the 50mV dual-mode threshold.

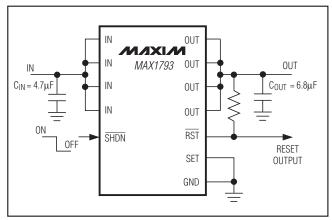


Figure 2. Typical Operating Circuit with Preset Output Voltage

#### Shutdown

A logic-low on  $\overline{SHDN}$  disables the MAX1793. In shutdown, the pass transistor, control circuitry, reference, and all internal circuits are turned off, reducing supply current to typically 0.1µA. Connect  $\overline{SHDN}$  to IN for normal operation. In shutdown,  $\overline{RST}$  goes low and OUT is discharged to GND with a  $5k\Omega$  internal resistance.

### **RST** Comparator

The MAX1793 features a low VouT indicator that asserts when the output voltage falls out of regulation. The open-drain  $\overline{RST}$  output goes low when OUT falls 6% below its nominal output voltage.  $\overline{RST}$  remains low for 4ms after OUT has returned to its nominal value. A 100k $\Omega$  pullup resistor from  $\overline{RST}$  to a suitable logic supply voltage (typically OUT) provides a logic control signal.  $\overline{RST}$  can be used as a power-on-reset (POR) signal to a microcontroller or can drive an external LED to indicate power failure.  $\overline{RST}$  is low during shutdown.

#### **Current Limiting**

The MAX1793 features a current limit that monitors the pass transistor, typically limiting short-circuit output current to 1.8A. The current limit is increased to approximately 2.8A when the output voltage is in regulation, improving performance with large transient loads. The output can be shorted to ground for an indefinite period of time without damaging the device.

#### **Thermal-Overload Protection**

Thermal-overload protection limits total power dissipation in the MAX1793. When the junction temperature exceeds  $T_J = +170^{\circ}C$ , a thermal sensor turns off the pass transistor, allowing the IC to cool. The thermal sensor turns the pass transistor on once the IC's junction temperature drops approximately 20°C. Continuous short-circuit conditions will result in a pulsed output.

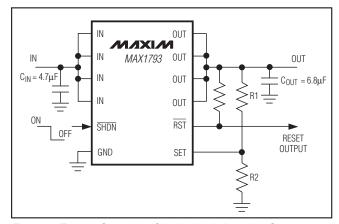


Figure 3. Typical Operating Circuit with Adjustable Output Voltage

Thermal-overload protection is designed to safeguard the MAX1793 in the event of fault conditions. For continuous operation, do not exceed the absolute maximum junction-temperature rating of  $T_J = +150$ °C.

#### **Operating Region and Power Dissipation**

Maximum power dissipation of the MAX1793 depends on the thermal resistance of the case and circuit board, the temperature difference between the die junction and ambient air, and the rate of air flow. The power dissipated by the device is:  $P = I_{OUT} (V_{IN} - V_{OUT})$ . The resulting maximum power dissipation is:

$$P_{MAX} = [(T_{J(MAX)} - T_{A})/(\theta_{JC} + \theta_{CA})]$$

where  $(T_{J(MAX)} - T_A)$  is the temperature difference between the maximum allowed die junction (+150°C) and the surrounding air,  $\theta_{JC}$  (junction-to-case) is the thermal resistance of the package chosen, and  $\theta_{CA}$  is the thermal resistance from the case through the PCB, copper traces, and other materials to the surrounding air. Figure 4 shows allowable power dissipation for typical PCBs at +25°C, +50°C, and +70°C ambient temperatures.

The MAX1793 TSSOP-EP package features an exposed thermal pad on its underside. This pad lowers the thermal resistance of the package by providing a direct heat conduction path from the die to the PCB. Additionally, the ground pin (GND) also channels heat. Connect the exposed thermal pad and GND to circuit ground by using a large pad (minimum 1in² recommended), or multiple vias to the ground plane.

## \_Applications Information

# Capacitor Selection and Regulator Stability

Capacitors are required at the input and output of the MAX1793. Connect a  $4.7\mu\text{F}$  capacitor between IN and ground (CIN) and a  $6.8\mu\text{F}$  capacitor between OUT and ground (COUT). CIN serves only to lower the source impedance of the input supply and may be smaller than  $4.7\mu\text{F}$  when the MAX1793 is powered from regulated power supplies or low-impedance batteries.

The output capacitor's equivalent series resistance (ESR) affects stability and output noise. C<sub>OUT</sub> ESR should be  $0.5\Omega$  or less to ensure stability and optimum transient response. Surface-mount ceramic capacitors have very low ESR and are commonly available in values up to  $10\mu\text{F}.$  Other low-ESR (<  $0.5\Omega$ ) capacitors, such as surface-mount tantalum or OS-CON, may also be used. Connect CIN and C<sub>OUT</sub> as close to the IC as possible to minimize the impact of PCB trace inductance.

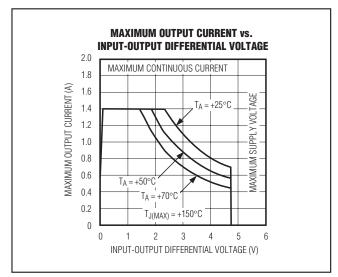


Figure 4. Power Operating Region: Maximum Output Current vs. Input-Output Differential Voltage

#### Noise, PSRR, and Transient Response

The MAX1793 output noise is typically 115µVRMS during normal operation. This is suitably low for most applications. See the output noise plot in the *Typical Operating Characteristics*.

The MAX1793 is designed to achieve low dropout voltage and low quiescent current in battery-powered systems while still maintaining good noise, transient response, and AC rejection. See the *Typical Operating Characteristics* for a plot of Power-Supply Rejection Ratio (PSRR) vs. Frequency. When operating from very noisy sources, supply noise rejection and transient response can be improved by increasing the values of the input and output capacitors and employing passive postfiltering.

#### Input-Output (Dropout) Voltage

A regulator's minimum input-to-output voltage differential (dropout voltage) determines the lowest usable supply voltage. In battery-powered systems, this determines the useful end-of-life battery voltage. Since a p-channel MOSFET is used as the pass device, dropout voltage is the product of RDS(ON) and load current (see the *Electrical Characteristics* and Dropout Voltage vs. Load Current in the *Typical Operating Characteristics*). The MAX1793 operating current typically remains below 225µA in dropout.

## \_Ordering Information (continued)

PART	TEMP RANGE	PIN- PACKAGE	V <sub>ООТ</sub> † (V)
MAX1793EUE-25	-40°C to +85°C	16 TSSOP-EP*	2.5 or Adj
MAX1793EUE-20	-40°C to +85°C	16 TSSOP-EP*	2.0 or Adj
MAX1793EUE-18	-40°C to +85°C	16 TSSOP-EP*	1.8 or Adj
MAX1793EUE-15	-40°C to +85°C	16 TSSOP-EP*	1.5 or Adj

<sup>\*</sup>EP = Exposed pad.

### Chip Information

**TRANSISTOR COUNT: 845** 

### **Package Information**

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
16 TSSOP-EP	U16E-3	<u>21-0108</u>

<sup>†</sup>Contact factory for other preset output voltages. /V Denotes an automotive qualified part.

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/00	Initial release	_
1	11/00	Added output voltages and updated Electrical Characteristics.	1–4, 7–9
2	9/09	Added the automotive version of the MAX1793.	1

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